Dual D-type flip-flop with set and reset; positive-edge triggerRev. 2 — 5 April 2013Product data sheet

1. General description

The 74LVC74A-Q100 is a dual edge triggered D-type flip-flop. It has individual data (nD) inputs, clock (nCP) inputs, set (nSD) and (nRD) inputs, and complementary nQ and nQ outputs.

The set and reset are asynchronous active LOW inputs and operate independently of the clock input. Information on the data input is transferred to the nQ output on the LOW-to-HIGH transition of the clock pulse. The nD inputs must be stable one set-up time prior to the LOW-to-HIGH clock transition, for predictable operation.

Schmitt trigger action at all inputs makes the circuit highly tolerant of slower input rise and fall times.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

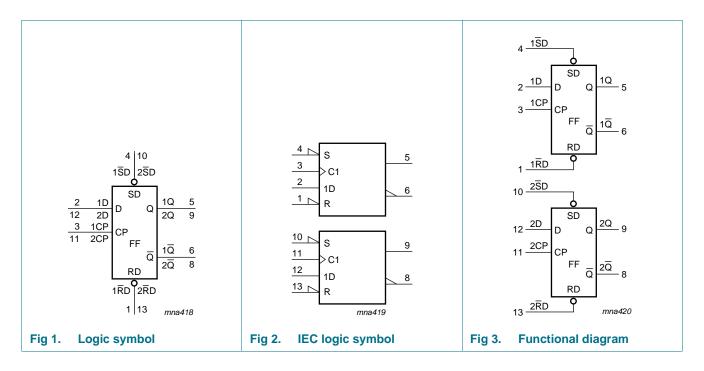
- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- 5 V tolerant inputs for interlacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Multiple package options



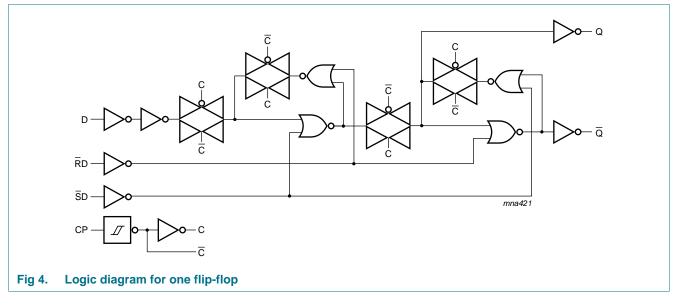
3. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LVC74AD-Q100	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1
74LVC74APW-Q100	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1
74LVC74ABQ-Q100	–40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm	SOT762-1

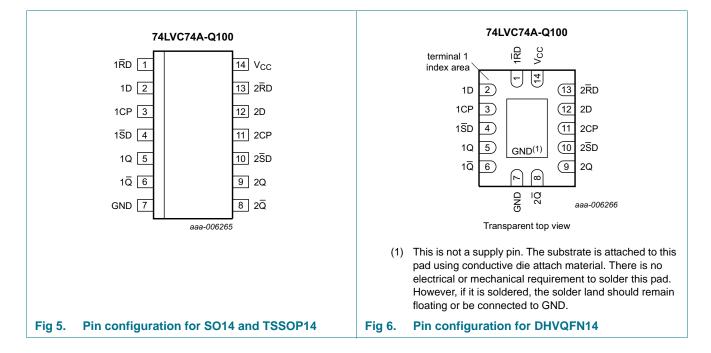
4. Functional diagram



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5. Pinning information



5.1 Pinning

5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
1RD, 2RD	1, 13	asynchronous reset-direct input (active LOW)
1D, 2D	2, 12	data input
1CP, 2CP	3, 11	clock input (LOW-to-HIGH, edge-triggered)
$1\overline{S}D, 2\overline{S}D$	4, 10	asynchronous set-direct input (active LOW)
1Q, 2Q	5, 9	true output
1 <u>Q</u> , 2 <u>Q</u>	6, 8	complement output
GND	7	ground (0 V)
V _{CC}	14	supply voltage

6. Functional description

Table 3.	Functio	n table ^[1]								
Input	put						Output			
n <mark>S</mark> D		nRD	n	СР		nD	nQ		nQ	
L		Н	Х			Х	Н		L	
Н		L	Х			Х	L		Н	
L		L	Х			Х	Н		Н	

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care

Table 4. Function table^[1]

Input		Output			
nSD	nRD	nCP	nD	nQ _{n+1}	nQ _{n+1}
Н	Н	↑	L	L	Н
Н	Н	↑	Н	Н	L

[1] H = HIGH voltage level; L = LOW voltage level; ↑ = LOW-to-HIGH transition; Q_{n+1} = state after the next LOW-to-HIGH CP transition; X = don't care

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7. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I _{OK}	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V	-	±50	mA
Vo	output voltage		<u>[2]</u> –0.5	$V_{CC} + 0.5$	V
lo	output current	$V_{O} = 0 V$ to V_{CC}	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	<u>[3]</u> _	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

8. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
V _{CC}	supply voltage	for maximum speed performance	1.65	-	3.6	V
		for low-voltage applications	1.2	-	3.6	V
VI	input voltage		0	-	5.5	V
Vo	output voltage		0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 1.65 V to 2.7 V	0	-	20	ns/V
		$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	0	-	10	ns/V

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9. Static characteristics

Table 7. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	85 °C	–40 °C to	Unit	
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
/ _{ІН}	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V_{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
/ _{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V_{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
/ _{он}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8$ mA; $V_{CC} = 2.3$ V	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24$ mA; $V_{CC} = 3.0$ V	2.2	-	-	2.0	-	V
/ _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = 100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	-	-	0.2	-	0.3	V
		I _O = 4 mA; V _{CC} = 1.65 V	-	-	0.45	-	0.65	V
		$I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		I_{O} = 12 mA; V_{CC} = 2.7 V	-	-	0.4	-	0.6	V
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
I	input leakage current	V_{CC} = 3.6 V; V_{I} = 5.5 V or GND	-	±0.1	±5	-	±20	μA
сс	supply current	$\label{eq:VCC} \begin{array}{l} V_{CC} = 3.6 \ V; \ V_{I} = V_{CC} \ \text{or GND}; \\ I_{O} = 0 \ A \end{array}$	-	0.1	10	-	40	μA
N _{CC}	additional supply current	per input pin; $V_{CC} = 2.7 V \text{ to } 3.6 V;$ $V_I = V_{CC} - 0.6 V; I_O = 0 A$	-	5	500	-	5000	μA
C _I	input capacitance	$V_{CC} = 0 V$ to 3.6 V; V _I = GND to V _{CC}	-	4.0	-	-	-	pF

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

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10. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 9.

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	–40 °C to +125 °C		Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
t _{pd}	propagation	nCP to nQ, n \overline{Q} ; see Figure 7	1					
	delay	$V_{CC} = 1.2 V$	-	15	-	-	-	ns
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	1.0	5.0	10.3	1.0	11.9	ns
		V_{CC} = 2.3 V to 2.7 V	1.8	2.9	5.8	1.8	6.7	ns
		$V_{CC} = 2.7 V$	1.0	2.7	6.0	1.0	7.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	1.0	2.6	5.2	1.0	6.5	ns
		$n\overline{SD}$ to nQ , $n\overline{Q}$; see <u>Figure 8</u>						
		$V_{CC} = 1.2 V$	-	15	-	-	-	ns
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	0.5	4.0	10.6	0.5	12.2	ns
		V_{CC} = 2.3 V to 2.7 V	1.0	2.4	6.1	1.0	7.1	ns
		$V_{CC} = 2.7 V$	1.0	2.9	6.4	1.0	8.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	1.0	2.2	5.4	1.0	7.0	ns
		nRD to nQ, nQ; see Figure 8						
		$V_{CC} = 1.2 V$	-	15	-	-	-	ns
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V	0.5	4.1	10.7	0.5	12.4	ns
		V_{CC} = 2.3 V to 2.7 V	1.0	2.4	6.1	1.0	7.1	ns
		$V_{CC} = 2.7 V$	1.0	3.0	6.4	1.0	8.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	1.0	2.2	5.4	1.0	7.0	ns
t _W	pulse width	clock HIGH or LOW; see Figure 7						
		V_{CC} = 1.65 V to 1.95 V	5.0	-	-	5.0	-	ns
		V_{CC} = 2.3 V to 2.7 V	4.0	-	-	4.0	-	ns
		$V_{CC} = 2.7 V$	3.3	-	-	4.5	-	ns
		$V_{CC} = 3.0 V \text{ to } 3.6 V$	3.3	1.3	-	4.5	-	ns
		set or reset LOW; see Figure 8						
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V	5.0	-	-	5.0	-	ns
		V_{CC} = 2.3 V to 2.7 V	4.0	-	-	4.0	-	ns
		$V_{CC} = 2.7 V$	3.3	-	-	4.5	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	3.3	1.7	-	4.5	-	ns
t _{rec}	recovery time	set or reset; see Figure 8						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	1.5	-	-	1.5	-	ns
		V_{CC} = 2.3 V to 2.7 V	1.5	-	-	1.5	-	ns
		$V_{CC} = 2.7 V$	1.5	-	-	1.0	-	ns
		V_{CC} = 3.0 V to 3.6 V	+1.0	-3.0	-	1.0	-	ns

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Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C te	o +125 °C	Unit
			Min	Typ[1]	Max	Min	Max	-	
t _{su}	set-up time	nD to nCP; see Figure 7			1				
		V_{CC} = 1.65 V to 1.95 V		3.0	-	-	3.0	-	ns
		V_{CC} = 2.3 V to 2.7 V		2.5	-	-	2.5	-	ns
		$V_{CC} = 2.7 V$		2.2	-	-	2.2	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		2.0	0.8	-	2.0	-	ns
t _h	hold time	nD to nCP; see <u>Figure 7</u>							
		V_{CC} = 1.65 V to 1.95 V		2.0	-	-	2.0	-	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	-	-	1.5	-	ns
		$V_{CC} = 2.7 V$		1.0	-	-	1.0	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		+1.0	-0.2	-	1.0	-	ns
f _{max}	maximum frequency	nCP; see Figure 7							
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		100	-	-	80	-	MHz
		V_{CC} = 2.3 V to 2.7 V		125	-	-	100	-	MHz
		$V_{CC} = 2.7 V$		150	-	-	120	-	MHz
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		150	250	-	120	-	MHz
t _{sk(o)}	output skew time	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	[3]	-	-	1.0	-	1.5	ns
C _{PD}	power	per flip-flop; $V_I = GND$ to V_{CC}	<u>[4]</u>						
	dissipation	V_{CC} = 1.65 V to 1.95 V		-	12.4	-	-	-	pF
	capacitance	V_{CC} = 2.3 V to 2.7 V		-	16.0	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	19.1	-	-	-	pF

Table 8. Dynamic characteristics ... continued

Voltages are referenced to GND (ground = 0 V). For test circuit see <u>Figure 9</u>.

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma(C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz; f_o = output frequency in MHz

 C_L = output load capacitance in pF

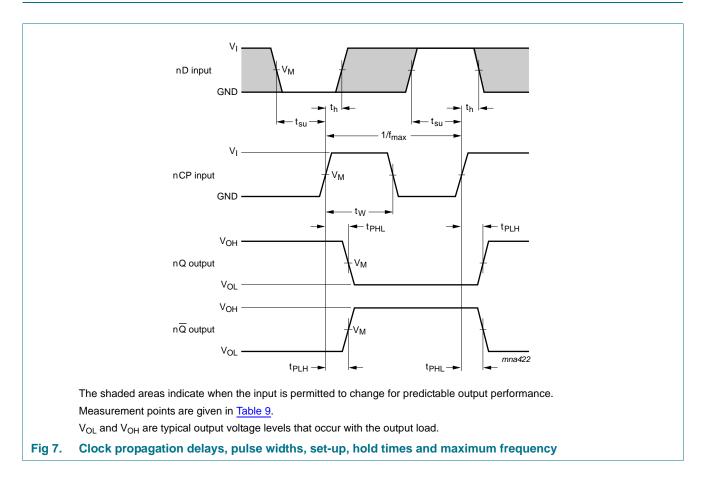
V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs

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11. AC waveforms



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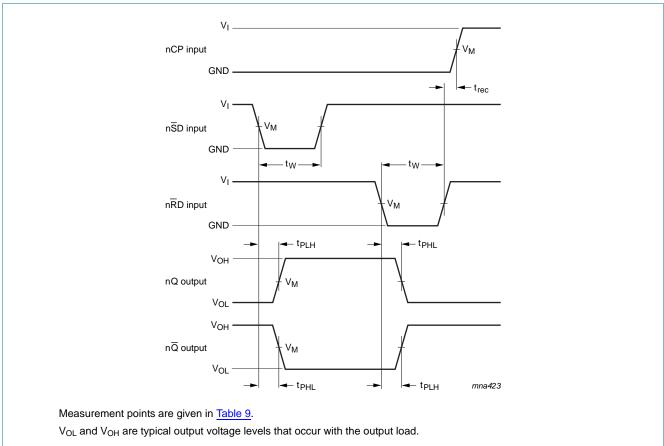


Fig 8. Set and reset propagation delays, pulse widths and recovery time

Table 9. Measurement points

Supply voltage	Input		Output	
V _{CC}	VI	V _M	V _M	
1.2 V	V _{CC}	$0.5 imes V_{CC}$	$0.5 imes V_{CC}$	
1.65 V to 1.95 V	V _{CC}	$0.5 imes V_{CC}$	$0.5 imes V_{CC}$	
2.3 V to 2.7 V	V _{CC}	$0.5 imes V_{CC}$	$0.5 imes V_{CC}$	
2.7 V	2.7 V	1.5 V	1.5 V	
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	

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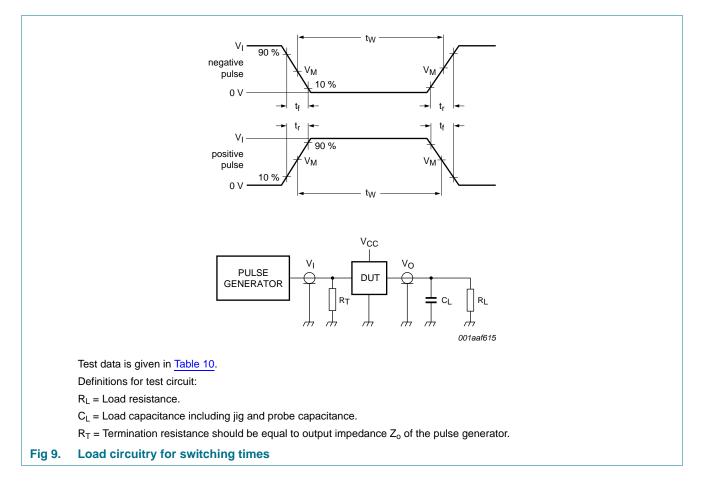


Table 10. Test data

Supply voltage	Input		Load		V _{EXT}	V _{EXT}			
V _{cc}	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}		
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND		
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND		
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	open	$2 \times V_{CC}$	GND		
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2 \times V_{CC}$	GND		
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND		

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12. Package outline

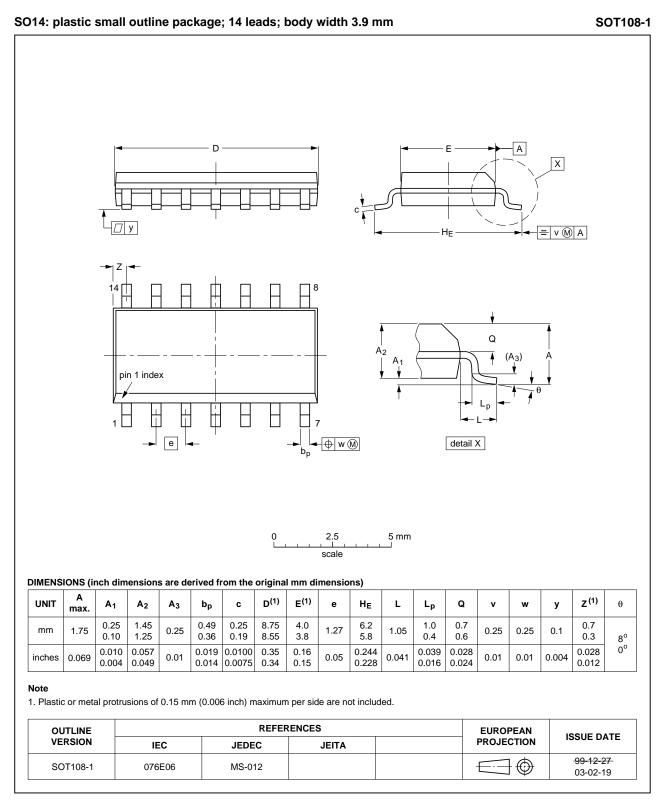


Fig 10. Package outline SOT108-1 (SO14)

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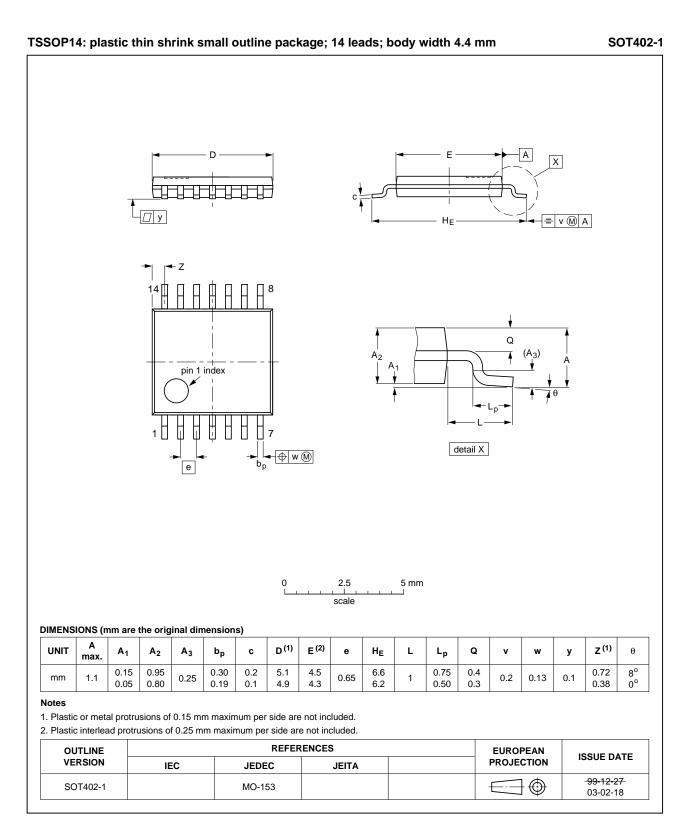
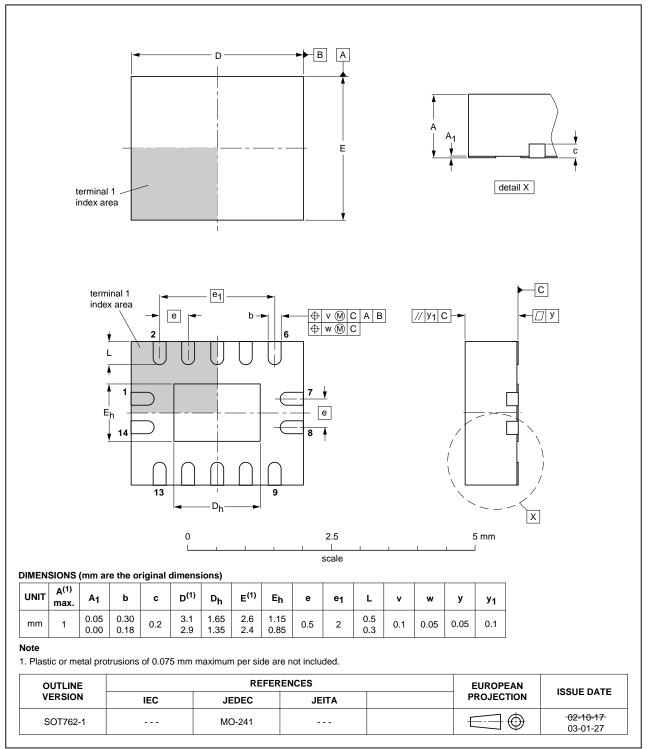


Fig 11. Package outline SOT402-1 (TSSOP14)

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DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

Fig 12. Package outline SOT762-1 (DHVQFN14)

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13. Abbreviations

AcronymDescriptionCDMCharged Device ModelDUTDevice Under TestESDElectroStatic DischargeHBMHuman Body Model	
DUT Device Under Test ESD ElectroStatic Discharge	
ESD ElectroStatic Discharge	
HBM Human Body Model	
MM Machine Model	
MIL Military	
TTL Transistor-Transistor Logic	

14. Revision history

Table 12. Revision h	istory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC74A_Q100 v.2	20130405	Product data sheet	-	74LVC74A_Q100 v.1
Modifications: • Section 2 "Features and benefits" removed redundant temperature range				
74LVC74A_Q100 v.1	20130326	Product data sheet	-	-

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Dual D-type flip-flop with set and reset; positive-edge trigger

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